TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

2SK2542

Switching Regulator Applications

Unit: mm

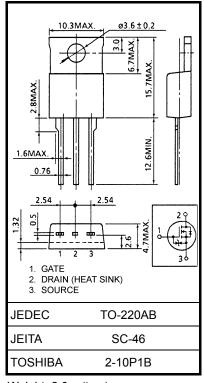
• 4-V gate drive

 $\begin{array}{ll} \bullet & Low \ drain-source \ ON \ resistance & : R_{DS} \ (ON) = 0.75 \ \Omega \ (typ.) \\ \bullet & High \ forward \ transfer \ admittance & : \ |Y_{fs}| = 7.0 \ S \ (typ.) \\ \bullet & Low \ leakage \ current & : I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 500 \ V) \\ \end{array}$

• Enhancement mode : $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

| Characteris | stics | Symbol | Rating | Unit | |
|--------------------------------------|------------------------|------------------|---------|------|--|
| Drain-source voltage | | V_{DSS} | 500 | V | |
| Drain-gate voltage (Ro | _{SS} = 20 kΩ) | V_{DGR} | 500 | V | |
| Gate-source voltage | | V _{GSS} | ±30 | V | |
| Drain current | DC (Note 1) | ΙD | 8 | Α | |
| | Pulse (Note 1) | I_{DP} | 32 | Α | |
| Drain power dissipation | n (Tc = 25°C) | P_{D} | 80 | W | |
| Single pulse avalanche | e energy (Note 2) | E _{AS} | 312 | mJ | |
| Avalanche current | | I _{AR} | 8 | Α | |
| Repetitive avalanche energy (Note 3) | | E _{AR} | 8 | mJ | |
| Channel temperature | | T _{ch} | 150 | °C | |
| Storage temperature ra | ange | T _{stg} | -55~150 | °C | |



Weight: 2.0 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

| Characteristics | Symbol | Max | Unit |
|--|------------------------|------|------|
| Thermal resistance, channel to case | R _{th (ch-c)} | 1.56 | °C/W |
| Thermal resistance, channel to ambient | R _{th (ch-a)} | 83.3 | °C/W |

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 8.3 mH, R_G = 25 Ω , I_{AR} = 8 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.



Electrical Characteristics (Ta = 25°C)

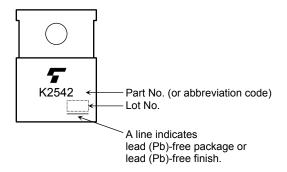
| Charac | cteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|-----------------|----------------------|---|-----|------|------|------|
| Gate leakage cu | ırrent | I _{GSS} | V _{GS} = ±25 V, V _{DS} = 0 V | _ | _ | ±10 | μΑ |
| Gate-source bre | eakdown voltage | V (BR) GSS | I _G = ±10 μA, V _{GS} = 0 V | ±30 | _ | _ | V |
| Drain cut-off cui | rrent | I _{DSS} | V _{DS} = 500 V, V _{DS} = 0 V | _ | _ | 100 | μA |
| Drain-source br | eakdown voltage | V (BR) DSS | I _D = 10 mA, V _{GS} = 0 V | 500 | _ | _ | V |
| Gate threshold v | voltage | V_{th} | V _{DS} = 10 V, I _D = 1 mA | 2.0 | _ | 4.0 | V |
| Drain-source Ol | N resistance | R _{DS} (ON) | V _{GS} = 10 V, I _D = 4 A | _ | 0.75 | 0.85 | Ω |
| Forward transfer | r admittance | Y _{fs} | V _{DS} = 10 V, I _D = 4 A | 3.5 | 7.0 | _ | S |
| Input capacitano | e | C _{iss} | | _ | 1300 | _ | |
| Reverse transfer capacitance | | C _{rss} | V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz | _ | 130 | _ | pF |
| Output capacitance | | Coss | | _ | 400 | _ | |
| Switching time | Rise time | t _r | $V_{GS} \stackrel{10 \text{ V}}{\text{O V}} \stackrel{\text{ID}}{\text{O V}} \stackrel{4 \text{ A}}{\text{O V}} \stackrel{\text{Out}}{\text{O V}} \stackrel{\text{RL}}{\text{O V}} = 50 \Omega$ $V_{DD} \stackrel{\text{ID}}{\text{O V}} \stackrel{\text{ID}}{\text{O V}} \stackrel{\text{ID}}{\text{O V}} = 200 \text{ V}$ | _ | 26 | _ | |
| | Turn-on time | t _{on} | | ı | 45 | ı | ne |
| | Fall time | t _f | | - | 40 | - | ns |
| | Turn-off time | t _{off} | Duty $\leq 1\%$, $t_{\rm w} = 10 \mu \rm s$ | _ | 140 | _ | |
| Total gate charge (Gate-source plus gate-drain) | | Qg | | _ | 30 | _ | |
| Gate-source charge | | Q _{gs} | $V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$ | | 17 | _ | nC |
| Gate-drain ("miller") charge | | Q_{gd} | | _ | 13 | _ | |

Source-Drain Ratings and Characteristics (Ta = 25°C)

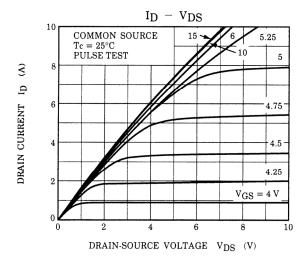
| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|------------------|--|-----|------|------|------|
| Continuous drain reverse current (Note 1) | I _{DR} | _ | _ | _ | 8 | Α |
| Pulse drain reverse current (Note 1) | I _{DRP} | - | _ | _ | 32 | Α |
| Forward voltage (diode) | V _{DSF} | I _{DR} = 8 A, V _{GS} = 0 V | _ | _ | -1.7 | V |
| Reverse recovery time | t _{rr} | I _{DR} = 8 A, V _{GS} = 0 V | 1 | 1200 | 1 | ns |
| Reverse recovery charge | Qrr | dI _{DR} / dt = 100 A / μs | _ | 10 | _ | μC |

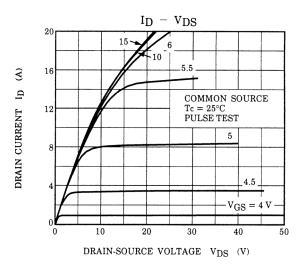
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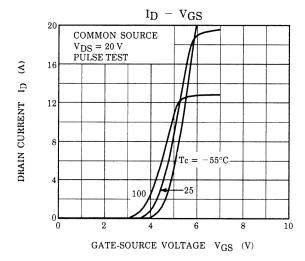
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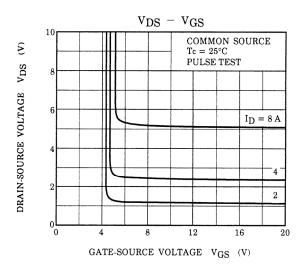


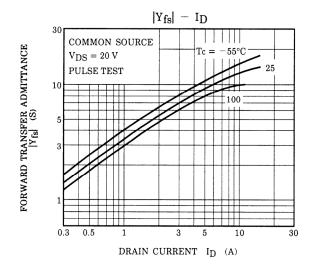
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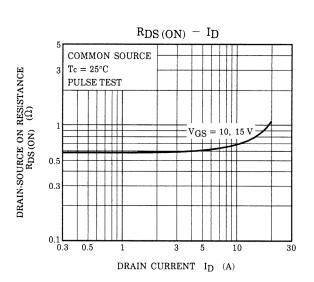


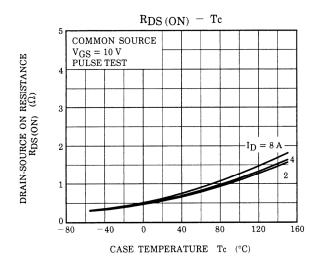


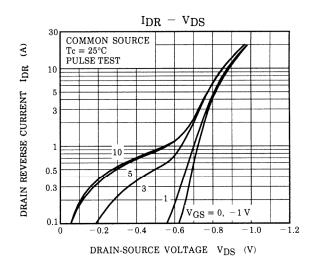


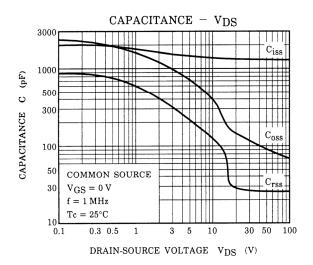


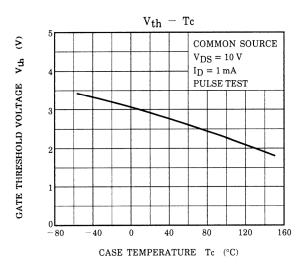


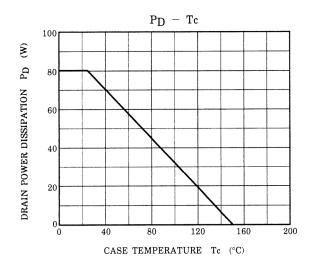


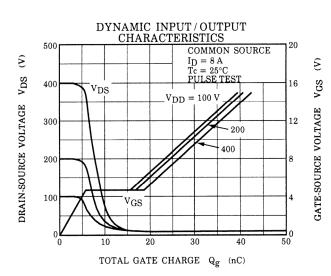


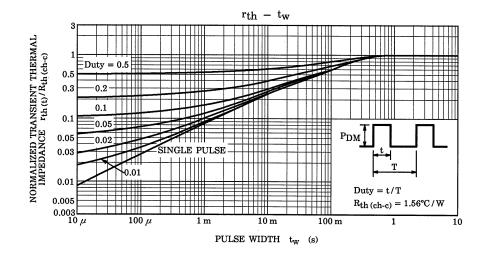


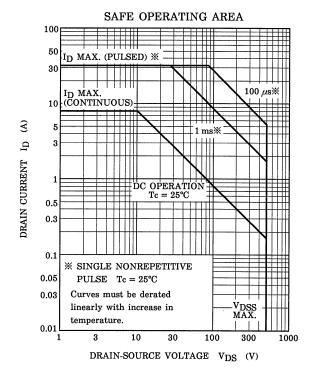


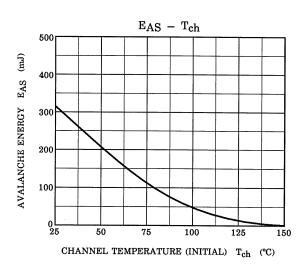


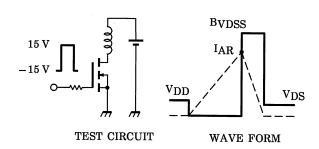












$$R_G$$
 = 25 Ω
 V_{DD} = 90 V, L = 8.3 mH

$$EAS = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$$

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